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#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I <sup>2</sup> C, Microwire, SPI, SSI, SSP, UART/USART, USB
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	40
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc11u22fbd48-30ql

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

- Standard JTAG (Joint Test Action Group) test interface for BSDL (Boundary Scan Description Language).
- Serial Wire Debug.
- Digital peripherals:
  - ◆ Up to 54 General-Purpose I/O (GPIO) pins with configurable pull-up/pull-down resistors, repeater mode, and open-drain mode.
  - Up to 8 GPIO pins can be selected as edge and level sensitive interrupt sources.
  - Two GPIO grouped interrupt modules enable an interrupt based on a programmable pattern of input states of a group of GPIO pins.
  - ♦ High-current source output driver (20 mA) on one pin.
  - ♦ High-current sink driver (20 mA) on true open-drain pins.
  - Four general-purpose counter/timers with a total of up to 5 capture inputs and 13 match outputs.
  - Programmable Windowed WatchDog Timer (WWDT) with a dedicated, internal low-power WatchDog Oscillator (WDO).
- Analog peripherals:
  - ◆ 10-bit ADC with input multiplexing among eight pins.
- Serial interfaces:
  - ◆ USB 2.0 full-speed device controller.
  - USART (Universal Synchronous Asynchronous Receiver/Transmitter) with fractional baud rate generation, internal FIFO, a full modem control handshake interface, and support for RS-485/9-bit mode and synchronous mode. USART supports an asynchronous smart card interface (ISO 7816-3).
  - Two SSP (Synchronous Serial Port) controllers with FIFO and multi-protocol capabilities.
  - ♦ I<sup>2</sup>C-bus interface supporting the full I<sup>2</sup>C-bus specification and Fast-mode Plus with a data rate of up to 1 Mbit/s with multiple address recognition and monitor mode.
- Clock generation:
  - Crystal Oscillator with an operating range of 1 MHz to 25 MHz (system oscillator).
  - 12 MHz high-frequency Internal RC oscillator (IRC) that can optionally be used as a system clock.
  - Internal low-power, low-frequency WatchDog Oscillator (WDO) with programmable frequency output.
  - PLL allows CPU operation up to the maximum CPU rate with the system oscillator or the IRC as clock sources.
  - ◆ A second, dedicated PLL is provided for USB.
  - Clock output function with divider that can reflect the crystal oscillator, the main clock, the IRC, or the watchdog oscillator.
- Power control:
  - Integrated PMU (Power Management Unit) to minimize power consumption during Sleep, Deep-sleep, Power-down, and Deep power-down modes.
  - Power profiles residing in boot ROM provide optimized performance and minimized power consumption for any given application through one simple function call.
  - Four reduced power modes: Sleep, Deep-sleep, Power-down, and Deep power-down.
  - Processor wake-up from Deep-sleep and Power-down modes via reset, selectable GPIO pins, watchdog interrupt, or USB port activity.

#### 32-bit ARM Cortex-M0 microcontroller

#### Table 3. Pin description

Symbol	Pin HVQFN33	Pin TFBGA48	Pin LQFP48	Pin LQFP64		Reset state [1]	Туре	Description
PIO0_5/SDA	11	H3	16	21	[4]	I; IA	I/O	<b>PIO0_5</b> — General purpose digital input/output pin (open-drain).
						-	I/O	<b>SDA</b> — I <sup>2</sup> C-bus data input/output (open-drain). High-current sink only if I <sup>2</sup> C Fast-mode Plus is selected in the I/O configuration register.
PIO0_6/USB_CONNECT/	15	H6	22	29	[3]	I; PU	I/O	PIO0_6 — General purpose digital input/output pin.
SCK0						-	0	<b>USB_CONNECT</b> — Signal used to switch an external 1.5 k $\Omega$ resistor under software control. Used with the SoftConnect USB feature.
						-	I/O	SCK0 — Serial clock for SSP0.
PIO0_7/CTS	16	G7	23	30	[5]	I; PU	I/O	<b>PIO0_7</b> — General purpose digital input/output pin (high-current output driver).
						-	I	CTS — Clear To Send input for USART.
PIO0_8/MISO0/	17	F8	27	36	[3]	I; PU	I/O	PIO0_8 — General purpose digital input/output pin.
CT16B0_MAT0						-	I/O	MISO0 — Master In Slave Out for SSP0.
						-	0	CT16B0_MAT0 — Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/	18	F7	28	37	[3]	I; PU	I/O	PIO0_9 — General purpose digital input/output pin.
CT16B0_MAT1						-	I/O	MOSI0 — Master Out Slave In for SSP0.
						-	0	CT16B0_MAT1 — Match output 1 for 16-bit timer 0.
SWCLK/PIO0_10/SCK0/ CT16B0_MAT2	19	E7	29	38	<u>[3]</u>	I; PU	I	<b>SWCLK</b> — Serial wire clock and test clock TCK for JTAG interface.
						-	I/O	PIO0_10 — General purpose digital input/output pin.
						-	0	SCK0 — Serial clock for SSP0.
						-	0	CT16B0_MAT2 — Match output 2 for 16-bit timer 0.
TDI/PIO0_11/AD0/	21	D8	32	42	[6]	I; PU	I	<b>TDI</b> — Test Data In for JTAG interface.
CT32B0_MAT3						-	I/O	PIO0_11 — General purpose digital input/output pin.
						-	I	AD0 — A/D converter, input 0.
						-	0	CT32B0_MAT3 — Match output 3 for 32-bit timer 0.
TMS/PIO0_12/AD1/	22	C7	33	44	[6]	I; PU	I	<b>TMS</b> — Test Mode Select for JTAG interface.
CT32B1_CAP0						-	I/O	PIO_12 — General purpose digital input/output pin.
						-	I	AD1 — A/D converter, input 1.
						-	I	CT32B1_CAP0 — Capture input 0 for 32-bit timer 1.
TDO/PIO0_13/AD2/	23	C8	34	45	[6]	I; PU	0	<b>TDO</b> — Test Data Out for JTAG interface.
CT32B1_MAT0						-	I/O	PIO0_13 — General purpose digital input/output pin.
						-	I	AD2 — A/D converter, input 2.
						-	0	CT32B1_MAT0 — Match output 0 for 32-bit timer 1.

#### 32-bit ARM Cortex-M0 microcontroller

#### Pin description Table 3.

Symbol	Pin HVQFN33	Pin TFBGA48	Pin LQFP48	Pin LQFP64		Reset state [1]	Туре	Description
TRST/PIO0_14/AD3/	24	B7	35	46	[6]	I; PU	I	<b>TRST</b> — Test Reset for JTAG interface.
CT32B1_MAT1						-	I/O	PIO0_14 — General purpose digital input/output pin.
						-	I	AD3 — A/D converter, input 3.
						-	0	CT32B1_MAT1 — Match output 1 for 32-bit timer 1.
SWDIO/PIO0_15/AD4/	25	B6	39	52	[6]	I; PU	I/O	SWDIO — Serial wire debug input/output.
CT32B1_MAT2						-	I/O	PIO0_15 — General purpose digital input/output pin.
						-	I	AD4 — A/D converter, input 4.
						-	0	CT32B1_MAT2 — Match output 2 for 32-bit timer 1.
PIO0_16/AD5/ CT32B1_MAT3/WAKEUP	26	A6	40	53	<u>[6]</u>	I; PU	I/O	<b>PIO0_16</b> — General purpose digital input/output pin. In Deep power-down mode, this pin functions as the WAKEUP pin with 20 ns glitch filter. Pull this pin HIGH externally to enter Deep power-down mode. Pull this pin LOW to exit Deep power-down mode. A LOW-going pulse as short as 50 ns wakes up the part.
						-	I	AD5 — A/D converter, input 5.
						-	0	CT32B1_MAT3 — Match output 3 for 32-bit timer 1.
PIO0_17/RTS/	30	A3	45	60	[3]	I; PU	I/O	PIO0_17 — General purpose digital input/output pin.
CT32B0_CAP0/SCLK						-	0	RTS — Request To Send output for USART.
						-	I	CT32B0_CAP0 — Capture input 0 for 32-bit timer 0.
						-	I/O	<b>SCLK</b> — Serial clock input/output for USART in synchronous mode.
PIO0_18/RXD/	31	B3	46	61	[3]	I; PU	I/O	PIO0_18 — General purpose digital input/output pin.
CT32B0_MAT0						-	I	<b>RXD</b> — Receiver input for USART. Used in UART ISP mode.
						-	0	CT32B0_MAT0 — Match output 0 for 32-bit timer 0.
PIO0_19/TXD/	32	B2	47	62	[3]	I; PU	I/O	PIO0_19 — General purpose digital input/output pin.
CT32B0_MAT1						-	0	<b>TXD</b> — Transmitter output for USART. Used in UART ISP mode.
						-	0	CT32B0_MAT1 — Match output 1 for 32-bit timer 0.
PIO0_20/CT16B1_CAP0	7	F2	9	11	[3]	I; PU	I/O	PIO0_20 — General purpose digital input/output pin.
						-	I	CT16B1_CAP0 — Capture input 0 for 16-bit timer 1.
PIO0_21/CT16B1_MAT0/	12	G4	17	22	[3]	I; PU	I/O	PIO0_21 — General purpose digital input/output pin.
MOSI1						-	0	CT16B1_MAT0 — Match output 0 for 16-bit timer 1.
						-	I/O	MOSI1 — Master Out Slave In for SSP1.
PIO0_22/AD6/	20	E8	30	40	[6]	I; PU	I/O	PIO0_22 — General purpose digital input/output pin.
CT16B1_MAT1/MISO1						-	I	AD6 — A/D converter, input 6.
						-	0	CT16B1_MAT1 — Match output 1 for 16-bit timer 1.
						-	I/O	MISO1 — Master In Slave Out for SSP1.

- Four programmable interrupt priority levels, with hardware priority level masking.
- Software interrupt generation.

#### 7.6.2 Interrupt sources

Each peripheral device has one interrupt line connected to the NVIC but can have several interrupt flags. Individual interrupt flags can also represent more than one interrupt source.

#### 7.7 IOCON block

The IOCON block allows selected pins of the microcontroller to have more than one function. Configuration registers control the multiplexers to allow connection between the pin and the on-chip peripherals.

Connect peripherals to the appropriate pins before activating the peripheral and before enabling any related interrupt. Activity of any enabled peripheral function that is not mapped to a related pin is treated as undefined.

#### 7.7.1 Features

- Programmable pull-up, pull-down, or repeater mode.
- All GPIO pins (except PIO0\_4 and PIO0\_5) are pulled up to 3.3 V ( $V_{DD}$  = 3.3 V) if their pull-up resistor is enabled.
- Programmable pseudo open-drain mode.
- Programmable 10 ns glitch filter on pins PIO0\_22, PIO0\_23, and PIO0\_11 to PIO0\_16. The glitch filter is turned on by default.
- Programmable hysteresis.
- Programmable input inverter.

#### 7.8 General-Purpose Input/Output GPIO

The GPIO registers control device pin functions that are not connected to a specific peripheral function. Pins can be dynamically configured as inputs or outputs. Multiple outputs can be set or cleared in one write operation.

LPC11U2x use accelerated GPIO functions:

- GPIO registers are a dedicated AHB peripheral so that the fastest possible I/O timing can be achieved.
- Entire port value can be written in one instruction.

Any GPIO pin providing a digital function can be programmed to generate an interrupt on a level, a rising or falling edge, or both.

The GPIO block consists of three parts:

- 1. The GPIO ports.
- 2. The GPIO pin interrupt block to control eight GPIO pins selected as pin interrupts.
- Two GPIO group interrupt blocks to control two combined interrupts from all GPIO pins.

The USART uses a fractional baud rate generator. Standard baud rates such as 115200 Bd can be achieved with any crystal frequency above 2 MHz.

#### 7.10.1 Features

- Maximum USART data bit rate of 3.125 Mbit/s.
- 16 byte receive and transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.
- Built-in fractional baud rate generator covering wide range of baud rates without a need for external crystals of particular values.
- Fractional divider for baud rate control, auto baud capabilities and FIFO control mechanism that enables software flow control implementation.
- Support for RS-485/9-bit mode.
- Support for modem control.
- Support for synchronous mode.
- Includes smart card interface.

#### 7.11 SSP serial I/O controller

The SSP controllers operate on a SSP, 4-wire SSI, or Microwire bus. It can interact with multiple masters and slaves on the bus. Only a single master and a single slave can communicate on the bus during a given data transfer. The SSP supports full duplex transfers, with frames of 4 bit to 16 bit of data flowing from the master to the slave and from the slave to the master. In practice, often only one of these data flows carries meaningful data.

#### 7.11.1 Features

- Maximum SSP speed of 25 Mbit/s (master) or 4.17 Mbit/s (slave) (in SSP mode)
- Compatible with Motorola SPI (Serial Peripheral Interface), 4-wire Texas Instruments SSI (Serial Synchronous Interface), and National Semiconductor Microwire buses
- Synchronous serial communication
- Master or slave operation
- 8-frame FIFOs for both transmit and receive
- 4-bit to 16-bit frame

#### 7.12 I<sup>2</sup>C-bus serial I/O controller

The LPC11U2x contain one I<sup>2</sup>C-bus controller.

The I<sup>2</sup>C-bus is bidirectional for inter-IC control using only two wires: a Serial CLock line (SCL) and a Serial DAta line (SDA). Each device is recognized by a unique address and can operate as either a receiver-only device (e.g., an LCD driver) or a transmitter with the capability to both receive and send information (such as memory). Transmitters and/or receivers can operate in either master or slave mode, depending on whether the chip has to initiate a data transfer or is only addressed. The I<sup>2</sup>C-bus is a multi-master bus, and more than one bus master connected to the interface can be controlled the bus.

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- Four match registers per timer that allow:
  - Continuous operation with optional interrupt generation on match.
  - Stop timer on match with optional interrupt generation.
  - Reset timer on match with optional interrupt generation.
- Up to four external outputs corresponding to match registers, with the following capabilities:
  - Set LOW on match.
  - Set HIGH on match.
  - Toggle on match.
  - Do nothing on match.
- The timer and prescaler can be configured to be cleared on a designated capture event. This feature permits easy pulse-width measurement by clearing the timer on the leading edge of an input pulse and capturing the timer value on the trailing edge.

#### 7.15 System tick timer

The ARM Cortex-M0 includes a system tick timer (SYSTICK) that is intended to generate a dedicated SYSTICK exception at a fixed time interval (typically 10 ms).

#### 7.16 Windowed WatchDog Timer (WWDT)

The purpose of the WWDT is to prevent an unresponsive system state. If software fails to update the watchdog within a programmable time window, the watchdog resets the microcontroller

#### 7.16.1 Features

- Internally resets chip if not periodically reloaded during the programmable time-out period.
- Optional windowed operation requires reload to occur between a minimum and maximum time period, both programmable.
- Optional warning interrupt can be generated at a programmable time before watchdog time-out.
- Software enables the WWDT, but a hardware reset or a watchdog reset/interrupt is required to disable the WWDT.
- Incorrect feed sequence causes reset or interrupt, if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.
- Selectable time period from  $(T_{cy(WDCLK)} \times 256 \times 4)$  to  $(T_{cy(WDCLK)} \times 2^{24} \times 4)$  in multiples of  $T_{cy(WDCLK)} \times 4$ .
- The Watchdog Clock (WDCLK) source can be selected from the IRC or the dedicated watchdog oscillator (WDO). The clock source selection provides a wide range of potential timing choices of watchdog operation under different power conditions.

#### 7.17 Clocking and power control

#### 7.17.1 Integrated oscillators

The LPC11U2x include three independent oscillators: the system oscillator, the Internal RC oscillator (IRC), and the watchdog oscillator. Each oscillator can be used for more than one purpose as required in a particular application.

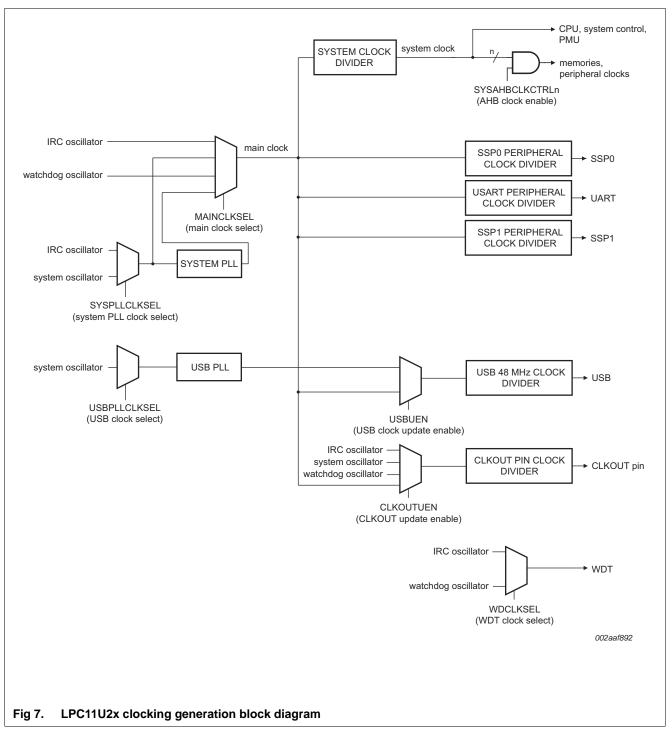
Following reset, the LPC11U2x operates from the internal RC oscillator until software switches to a different clock source. The IRC allows the system to operate without any external crystal and the bootloader code to operate at a known frequency.

See Figure 7 for an overview of the LPC11U2x clock generation.

#### **NXP Semiconductors**

## LPC11U2x

#### 32-bit ARM Cortex-M0 microcontroller



#### 7.17.1.1 Internal RC oscillator

The IRC can be used as the clock source for the WDT, and/or as the clock that drives the system PLL and then the CPU. The nominal IRC frequency is 12 MHz.

Upon power-up, any chip reset, or wake-up from Deep power-down mode, the LPC11U2x use the IRC as the clock source. Software can later switch to one of the other available clock sources.

Product data sheet

#### 7.17.1.2 System oscillator

The system oscillator can be used as the clock source for the CPU, with or without using the PLL. On the LPC11U2x, use the system oscillator to provide the clock source to USB.

The system oscillator operates at frequencies of 1 MHz to 25 MHz. This frequency can be boosted to a higher frequency, up to the maximum CPU operating frequency, by the system PLL.

#### 7.17.1.3 Watchdog oscillator

The watchdog oscillator can be used as a clock source that directly drives the CPU, the watchdog timer, or the CLKOUT pin. The watchdog oscillator nominal frequency is programmable between 7.8 kHz and 1.7 MHz. The frequency spread over processing and temperature is  $\pm 40$  % (see also Table 13).

#### 7.17.2 System PLL and USB PLL

The LPC11U2x contain a system PLL and a dedicated PLL for generating the 48 MHz USB clock. The system and USB PLLs are identical.

The PLL accepts an input clock frequency in the range of 10 MHz to 25 MHz. The input frequency is multiplied up to a high frequency with a Current Controlled Oscillator (CCO). The multiplier can be an integer value from 1 to 32. The CCO operates in the range of 156 MHz to 320 MHz. To support this frequency range, an additional divider keeps the CCO within its frequency range while the PLL is providing the desired output frequency. The output divider can be set to divide by 2, 4, 8, or 16 to produce the output clock. The PLL output frequency must be lower than 100 MHz. Since the minimum output divider value is 2, it is insured that the PLL output has a 50 % duty cycle. The PLL is turned off and bypassed following a chip reset. Software can enable the PLL later. The program must configure and activate the PLL, wait for the PLL to lock, and then connect to the PLL as a clock source. The PLL settling time is 100  $\mu$ s.

#### 7.17.3 Clock output

The LPC11U2x feature a clock output function that routes the IRC oscillator, the system oscillator, the watchdog oscillator, or the main clock to an output pin.

#### 7.17.4 Wake-up process

The LPC11U2x begin operation by using the 12 MHz IRC oscillator as the clock source at power-up and when awakened from Deep power-down mode. This mechanism allows chip operation to resume quickly. If the application uses the main oscillator or the PLL, software must enable these components and wait for them to stabilize. Only then can the system use the PLL and main oscillator as a clock source.

#### 7.17.5 Power control

The LPC11U2x support various power control features. There are four special modes of processor power reduction: Sleep mode, Deep-sleep mode, Power-down mode, and Deep power-down mode. The CPU clock rate can also be controlled as needed by changing clock sources, reconfiguring PLL values, and/or altering the CPU clock divider value. This power control mechanism allows a trade-off of power versus processing speed based on application requirements. In addition, a register is provided for shutting down the clocks to individual on-chip peripherals. This register allows fine-tuning of power

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#### 7.18 Emulation and debugging

Debug functions are integrated into the ARM Cortex-M0. Serial wire debug functions are supported in addition to a standard JTAG boundary scan. The ARM Cortex-M0 is configured to support up to four breakpoints and two watch points.

The  $\overline{\text{RESET}}$  pin selects between the JTAG boundary scan ( $\overline{\text{RESET}}$  = LOW) and the ARM SWD debug ( $\overline{\text{RESET}}$  = HIGH). The ARM SWD debug port is disabled while the LPC11U2x is in reset.

To perform boundary scan testing, follow these steps:

- 1. Erase any user code residing in flash.
- 2. Power up the part with the RESET pin pulled HIGH externally.
- 3. Wait for at least 250  $\mu$ s.
- 4. Pull the RESET pin LOW externally.
- 5. Perform boundary scan operations.
- 6. Once the boundary scan operations are completed, assert the TRST pin to enable the SWD debug mode, and release the RESET pin (pull HIGH).

**Remark:** The JTAG interface cannot be used for debug purposes.

### 9. Static characteristics

#### Table 5.Static characteristics

 $T_{amb} = -40 \$ °C to +85 °C, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
V <sub>DD</sub>	supply voltage (core and external rail)		[2]	1.8	3.3	3.6	V
I <sub>DD</sub>	supply current	Active mode; $V_{DD} = 3.3 V$ ; $T_{amb} = 25 °C$ ; code					
		while(1){}					
		executed from flash;				3.3       3.6         2       -         7       -         1       -         360       -         2       -         360       -         2       -         360       -         220       -         0.5       10         0.5       10         0.5       10         0.5       10         -       5.0         -       VDD         -       -         -       0.3VD	
		system clock = 12 MHz	[3][4][5] [6][7][8]	-	2	-	mA
		system clock = 50 MHz	-	7	-	mA	
		Sleep mode; V <sub>DD</sub> = 3.3 V; T <sub>amb</sub> = 25 °C;	[3][4][5] [6][7][8]	-	1	-	mA
		system clock = 12 MHz					
		Deep-sleep mode; $V_{DD} = 3.3 V$ ; T <sub>amb</sub> = 25 °C	-	360	-	μA	
		Power-down mode; $V_{DD} = 3.3 V$ ; T <sub>amb</sub> = 25 °C		-	2	-	μA
		Deep power-down mode; V <sub>DD</sub> = 3.3 V; T <sub>amb</sub> = 25 °C	[10]	-	220	-	nA
Standard	d port pins, RESET				1	]	
IIL	LOW-level input current	V <sub>I</sub> = 0 V; on-chip pull-up resistor disabled		-	0.5	10	nA
IIH	HIGH-level input current	$V_I = V_{DD}$ ; on-chip pull-down resistor disabled		-	0.5	10	nA
I <sub>OZ</sub>	OFF-state output current	$V_O = 0 V$ ; $V_O = V_{DD}$ ; on-chip pull-up/down resistors disabled		-	0.5	10	nA
VI	input voltage	pin configured to provide a digital function	[11][12] [13]	0	-	5.0	V
Vo	output voltage	output active		0	-	V <sub>DD</sub>	V
VIH	HIGH-level input voltage			0.7V <sub>DD</sub>	-	-	V
V <sub>IL</sub>	LOW-level input voltage			-	-	$0.3V_{DD}$	V
V <sub>hys</sub>	hysteresis voltage			-	0.4	-	V
V <sub>ОН</sub>	HIGH-level output	$2.0~V \leq V_{DD} \leq 3.6~V;~I_{OH} = -4~mA$		$V_{DD}-0.4$	-	-	V
	voltage	1.8 V $\leq$ V_{DD} < 2.0 V; I_{OH} = –3 mA		$V_{DD}-0.4$	-	-	V
V <sub>OL</sub>	LOW-level output	$2.0~\text{V} \leq \text{V}_{DD} \leq 3.6~\text{V};~\text{I}_{OL}$ = 4 mA		-	-	0.4	V
	voltage	1.8 V $\leq$ V <sub>DD</sub> < 2.0 V; I <sub>OL</sub> = 3 mA		-	-	0.4	V
I <sub>OH</sub>	HIGH-level output current	$V_{OH} = V_{DD} - 0.4 \text{ V};$ 2.0 V $\leq V_{DD} \leq 3.6 \text{ V}$		-4	-	-	mA
		$1.8 \text{ V} \le \text{V}_{\text{DD}} < 2.0 \text{ V}$		-3	-	-	mA

Symbo	I Parameter	Conditions	Min	Typ <u>[1]</u>	Max	Unit
Pin cap	pacitance					
Cio input/output		pins configured for analog function	-	-	7.1	pF
	capacitance	I <sup>2</sup> C-bus pins (PIO0_4 and PIO0_5)	-	-	2.5	pF
		pins configured as GPIO	-	-	2.8	pF

### Table 5. Static characteristics ...continued

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

For USB operation 3.0 V  $\leq$  V\_DD  $\leq$  3.6 V. Guaranteed by design. [2]

IRC enabled; system oscillator disabled; system PLL disabled. [3]

I<sub>DD</sub> measurements were performed with all pins configured as GPIO outputs driven LOW and pull-up resistors disabled. [4]

BOD disabled. [5]

- [6] All peripherals disabled in the AHBCLKCTRL register. Peripheral clocks to USART, SSP0/1 disabled in the SYSCON block.
- [7] USB\_DP and USB\_DM pulled LOW externally.
- [8] Low-current mode PWR\_LOW\_CURRENT selected when running the set\_power routine in the power profiles.

[9] IRC disabled; system oscillator enabled; system PLL enabled.

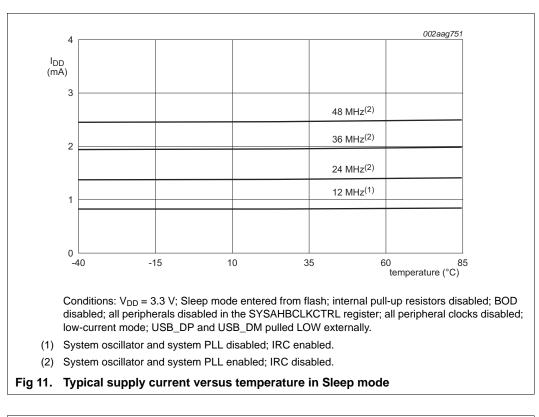
[10] WAKEUP pin pulled HIGH externally. An external pull-up resistor is required on the RESET pin for the Deep power-down mode.

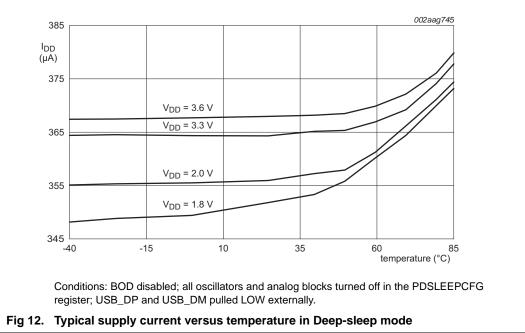
- [11] Including voltage on outputs in 3-state mode.
- [12] V<sub>DD</sub> supply voltage must be present.
- [13] 3-state outputs go into 3-state mode in Deep power-down mode.
- [14] Allowed as long as the current limit does not exceed the maximum current allowed by the device.

[15] To V<sub>SS</sub>.

[16] Includes external resistors of 33  $\Omega \pm 1$  % on USB\_DP and USB\_DM.

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- [2] The typical frequency spread over processing and temperature (T<sub>amb</sub> =  $-40 \degree C$  to +85  $\degree C$ ) is ±40 %.
- [3] See the LPC11Uxx user manual.

### 10.4 I/O pins

#### Table 14. Dynamic characteristics: I/O pins<sup>[1]</sup>

 $T_{amb} = -40$  °C to +85 °C; 3.0 V  $\leq V_{DD} \leq 3.6$  V.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>r</sub>	rise time	pin configured as output	3.0	-	5.0	ns
t <sub>f</sub>	fall time	pin configured as output	2.5	-	5.0	ns

[1] Applies to standard port pins and RESET pin.

#### 10.5 I<sup>2</sup>C-bus

#### Table 15. Dynamic characteristic: I<sup>2</sup>C-bus pins<sup>[1]</sup>

 $T_{amb} = -40 \ ^{\circ}C \ to +85 \ ^{\circ}C.$ 

Symbol	Parameter		Conditions	Min	Max	Unit
f <sub>SCL</sub>	SCL clock		Standard-mode	0	100	kHz
	frequency		Fast-mode	0	400	kHz
		fall time [3][4][5][6] LOW period of the SCL clock HIGH period of the SCL clock	Fast-mode Plus	0	1	MHz
t <sub>f</sub>	fall time	[3][4][5][6]	of both SDA and SCL signals	-	300	ns
			Standard-mode			
			Fast-mode	$20 + 0.1 \times C_b$	300	ns
		Fast-mode Plus	-	120	ns	
t <sub>LOW</sub>			Standard-mode	4.7	-	μs
SCL clock	SCL clock		Fast-mode	1.3	-	μs
			Fast-mode Plus	0.5	-	μs
t <sub>HIGH</sub>	SCL clock HIGH period of the	Standard-mode	4.0	-	μS	
	SCL clock	time [3][4][5][6] W period of the L clock GH period of the L clock ta hold time [3][7][8]	Fast-mode	0.6	-	μs
			Fast-mode Plus	0.26	-	μS
t <sub>HD;DAT</sub>	HIGH period of the SCL clock	Standard-mode	0	-	μS	
			Fast-mode	0	-	μS
			Fast-mode Plus	0	-	μs
t <sub>SU;DAT</sub>	data set-up time	[9][10]	Standard-mode	250	-	ns
			Fast-mode	100	-	ns
			Fast-mode Plus	50	-	ns

[1] See the I<sup>2</sup>C-bus specification UM10204 for details.

[2] Parameters are valid over operating temperature range unless otherwise specified.

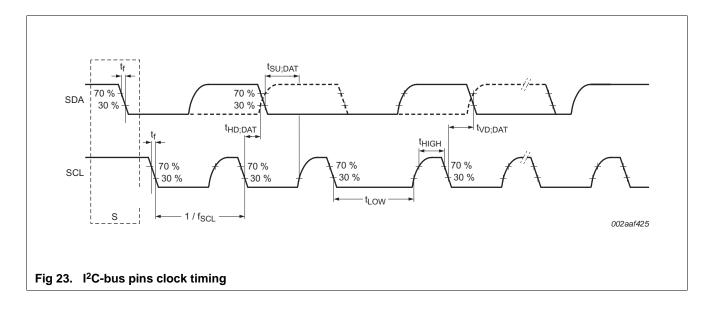
- [3] A device must internally provide a hold time of at least 300 ns for the SDA signal (with respect to the V<sub>IH</sub>(min) of the SCL signal) to bridge the undefined region of the falling edge of SCL.
- [4]  $C_b$  = total capacitance of one bus line in pF.
- [5] The maximum t<sub>f</sub> for the SDA and SCL bus lines is specified at 300 ns. The maximum fall time for the SDA output stage t<sub>f</sub> is specified at 250 ns. This allows series protection resistors to be connected in between the SDA and the SCL pins and the SDA/SCL bus lines without exceeding the maximum specified t<sub>f</sub>.
- [6] In Fast-mode Plus, fall time is specified the same for both output stage and bus timing. If series resistors are used, designers should allow for this when considering bus timing.

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- [7] The maximum  $t_{HD;DAT}$  could be 3.45  $\mu$ s and 0.9  $\mu$ s for Standard-mode and Fast-mode but must be less than the maximum of  $t_{VD;DAT}$  or  $t_{VD;ACK}$  by a transition time (see *UM10204*). This maximum must only be met if the device does not stretch the LOW period ( $t_{LOW}$ ) of the SCL signal. If the clock stretches the SCL, the data must be valid by the set-up time before it releases the clock.
- [8] tHD;DAT is the data hold time that is measured from the falling edge of SCL; applies to data in transmission and the acknowledge.
- [9] tSU;DAT is the data set-up time that is measured with respect to the rising edge of SCL; applies to data in transmission and the acknowledge.
- [10] A Fast-mode I<sup>2</sup>C-bus device can be used in a Standard-mode I<sup>2</sup>C-bus system but the requirement  $t_{SU;DAT} = 250$  ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line  $t_{r(max)} + t_{SU;DAT} = 1000 + 250 = 1250$  ns (according to the Standard-mode I<sup>2</sup>C-bus specification) before the SCL line is released. Also the acknowledge timing must meet this set-up time.

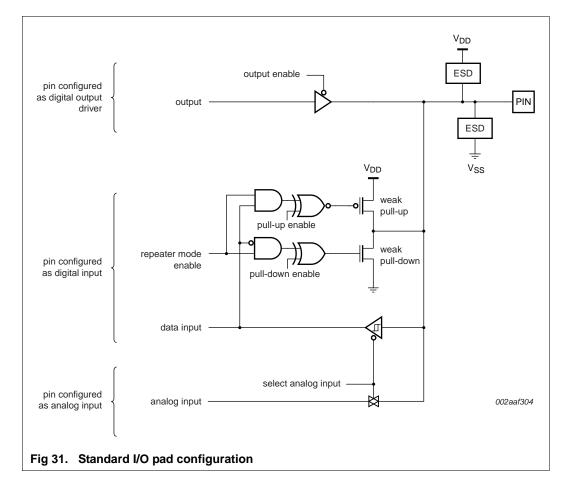


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### 11.4 Standard I/O pad configuration

Figure 31 shows the possible pin modes for standard I/O pins with analog input function:

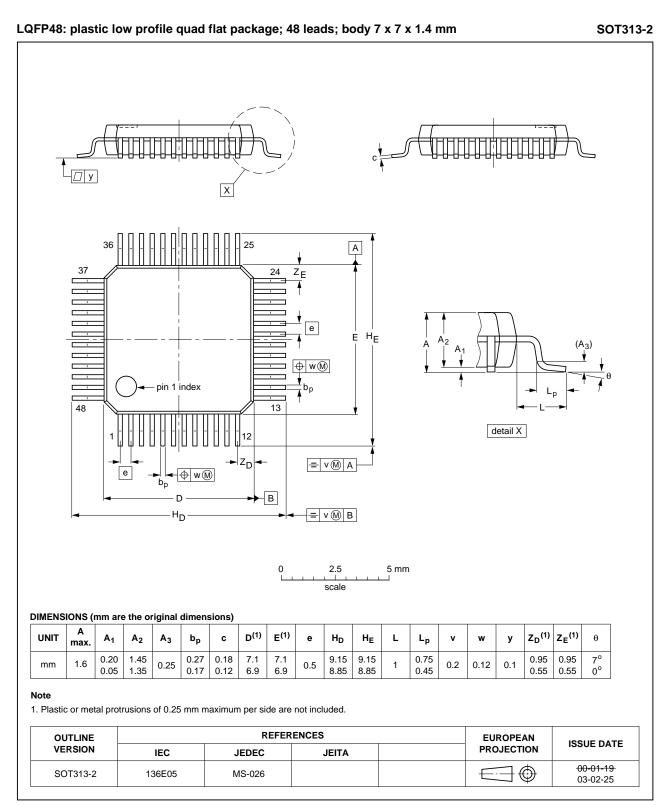
- Digital output driver
- Digital input: Pull-up enabled/disabled
- Digital input: Pull-down enabled/disabled
- Digital input: Repeater mode enabled/disabled
- Analog input



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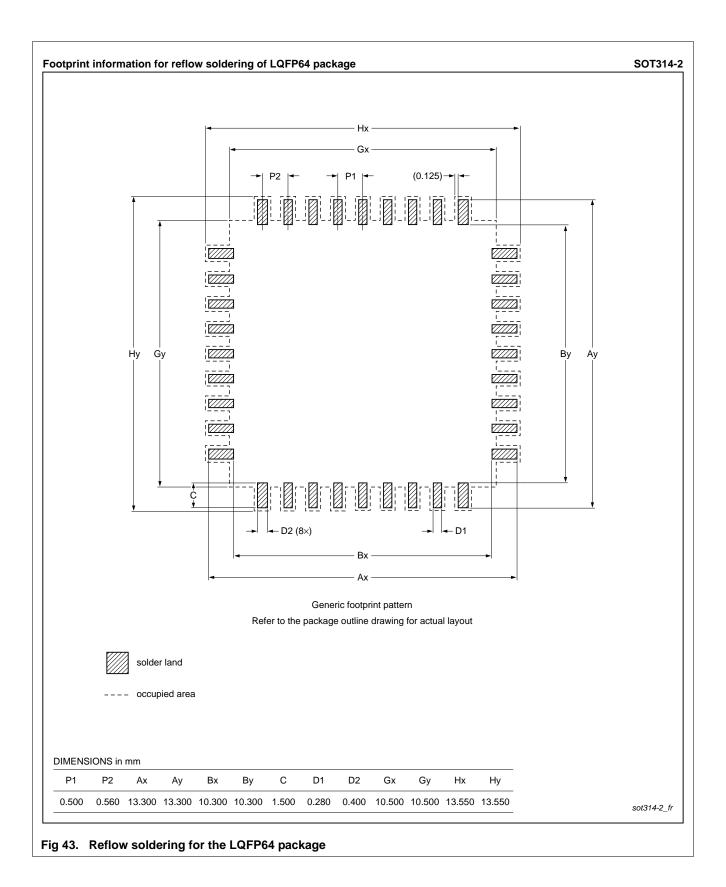
#### Fig 36. Package outline LQFP48 (SOT313-2)

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### 16. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes						
LPC11U2x v.2.3	20140327	Product data sheet	-	LPC11U2X v.2.2						
	Part LPC11U22F	Part LPC11U22FBD48/301 added.								
LPC11U2X v.2.2	20140311	Product data sheet	-	LPC11U2X v.2.1						
Modifications:	•	ction 11.1 "Suggested USB inte I <sup>2</sup> C-bus and RESET pin descrip		-						
LPC11U2X v.2.1	20130917	Product data sheet		LPC11U2X v.2						
Modifications:	<ul> <li>Number of Q</li> <li>Table 3: Adq</li> <li>Table 7: Rei</li> <li>Added Sect</li> <li>Programma</li> <li>Table 5 "Sta</li> <li>Updated Se</li> <li>Table 4 "Lim <ul> <li>Updated</li> <li>Updated</li> <li>Table 10 "El</li> <li>Remove</li> <li>Changeo program</li> </ul> </li> </ul>	CAP and MAT functions for time ded "5 V tolerant pad" to RESE moved BOD interrupt level 0. ion 11.6 "ADC effective input im ble glitch filter is enabled by dei tic characteristics" added Pin ca ction 11.1 "Suggested USB inter- niting values": $V_{DD}$ min and max. $V_{I}$ conditions. EPROM characteristics": d f <sub>clk</sub> and t <sub>er</sub> ; the user does not the t <sub>prog</sub> from 1.1 ms to 2.9 ms , thus the total program time is the e of Figure 29 from "USB interfate	F/PIO0_0 table note opedance". fault. See Section 7 apacitance section. erface solutions". have control over the s; the EEPROM IAP	e 1. e. 7.7.1. nese parameters. P always does an erase and						
	<ul> <li>with soft-connect".</li> <li>Section 10.7 "USB interface" added. Parameter t<sub>EOPR1</sub> and t<sub>EOPR2</sub> renamed to t<sub>EOPR</sub>.</li> </ul>									
			neter t <sub>EOPR1</sub> and t <sub>EO</sub>							
LPC11U2X v.2	20120113	Product data sheet	-	LPC11U2X v.1						
Modifications:		<ul> <li>Use of USB with power profiles specified (Section 7.17.5.1).</li> </ul>								
	-	• SSP dynamic characteristics added (Table 16).								
	-	<ul> <li>IRC dynamic characteristics added (Table 12).</li> </ul>								
	<ul> <li>Data sheet s</li> </ul>	status changed to Product data	sheet.							
LPC11U2X v.1	20111129	Preliminary data sheet	-	-						

#### Table 21. Revision history

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